

## 4 M x 4-Bit Dynamic RAM (2 k-refresh)

HYB 5117400AJ-50/-60/-70/-80  
HYB 5117400ASJ-50/-60/-70/-80

### Preliminary Information

- 4 194 304 words by 4-bit organization
- 0 to 70 °C operating temperature
- Fast access and cycle time
  - $\overline{\text{RAS}}$  access time:
    - 50 ns (-50 version)
    - 60 ns (-60 version)
    - 70 ns (-70 version)
    - 80 ns (-80 version)
  - Cycle time:
    - 95 ns (-50 version)
    - 110 ns (-60 version)
    - 130 ns (-70 version)
    - 150 ns (-80 version)
  - $\overline{\text{CAS}}$  access time:
    - 15 ns ( -50,-60 version)
    - 20 ns ( -70,-80 version)
- Fast page mode cycle time
  - 35 ns (-50 version)
  - 40 ns (-60 version)
  - 45 ns (-70 version)
  - 50 ns (-80 version)
- Single + 5 V ( $\pm 10\%$ ) supply
- Low power dissipation
  - max. 660 active mW (-50 version)
  - max. 605 active mW (-60 version)
  - max. 550 active mW (-70 version)
  - max. 495 active mW (-80 version)
  - 11 mW standby (TTL)
  - 5.5 mW standby (MOS)
- Output unlatched at cycle end allows two-dimensional chip selection
- Read, write, read-modify-write,  $\overline{\text{CAS}}$ -before- $\overline{\text{RAS}}$  refresh,  $\overline{\text{RAS}}$ -only refresh, hidden refresh, test mode
- Fast page mode capability
- All inputs, outputs and clocks fully TTL-compatible
- 2048 refresh cycles / 32 ms
- Plastic Package:      P-SOJ-28/24-1 400 mil  
                                 P-SOJ-26/24-1 300 mil

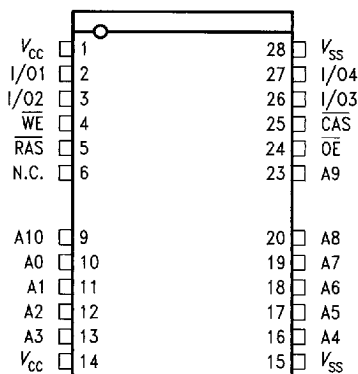
The HYB 5117400AS/ASJ is the new generation dynamic RAM organized as 4194304 words by 4-bits. The HYB 5117400AS/ASJ utilizes a submicron CMOS silicon gate process technology, as well as advanced circuit techniques to provide wide operating margins, both internally and for the system user. Multiplexed address inputs permit the HYB 5117400AS/ASJ to be packaged in a standard SOJ 28/24 400 mil or SOJ 26/24 300 mil wide plastic package. These packages provide high system bit densities and are compatible with commonly used automatic testing and insertion equipment. System-oriented features include single + 5 V ( $\pm 10\%$ ) power supply, direct interfacing with high-performance logic device families such as Schottky TTL.

### Ordering Information

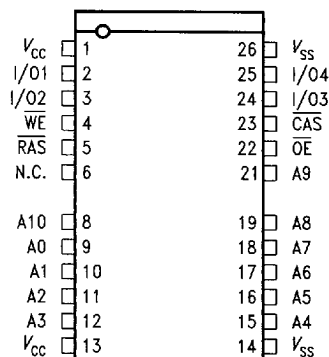
| Type              | Ordering Code | Package               | Descriptions             |
|-------------------|---------------|-----------------------|--------------------------|
| HYB 5117400ASJ-50 | Q67100-Q905   | P-SOJ-28/24-1 400 mil | DRAM (access time 50 ns) |
| HYB 5117400ASJ-60 | Q67100-Q906   | P-SOJ-28/24-1 400 mil | DRAM (access time 60 ns) |
| HYB 5117400ASJ-70 | Q67100-Q907   | P-SOJ-28/24-1 400 mil | DRAM (access time 70 ns) |
| HYB 5117400ASJ-80 | Q67100-Q908   | P-SOJ-28/24-1 400 mil | DRAM (access time 80 ns) |
| HYB 5117400AJ-50  | Q67100-Q913   | P-SOJ-26/24-1 300 mil | DRAM (access time 50 ns) |
| HYB 5117400AJ-60  | Q67100-Q914   | P-SOJ-26/24-1 300 mil | DRAM (access time 60 ns) |
| HYB 5117400AJ-70  | Q67100-Q915   | P-SOJ-26/24-1 300 mil | DRAM (access time 70 ns) |
| HYB 5117400AJ-80  | Q67100-Q916   | P-SOJ-26/24-1 300 mil | DRAM (access time 80 ns) |

### Pin Names

|                           |                       |
|---------------------------|-----------------------|
| A0-A10                    | Address Inputs        |
| $\overline{\text{RAS}}$   | Row Address Strobe    |
| $\overline{\text{OE}}$    | Output Enable         |
| I/O1-I/O4                 | Data Input/Output     |
| $\overline{\text{CAS}}$   | Column Address Strobe |
| $\overline{\text{WRITE}}$ | Read/Write Input      |
| $V_{\text{CC}}$           | Power Supply (+ 5 V)  |
| $V_{\text{SS}}$           | Ground (0 V)          |



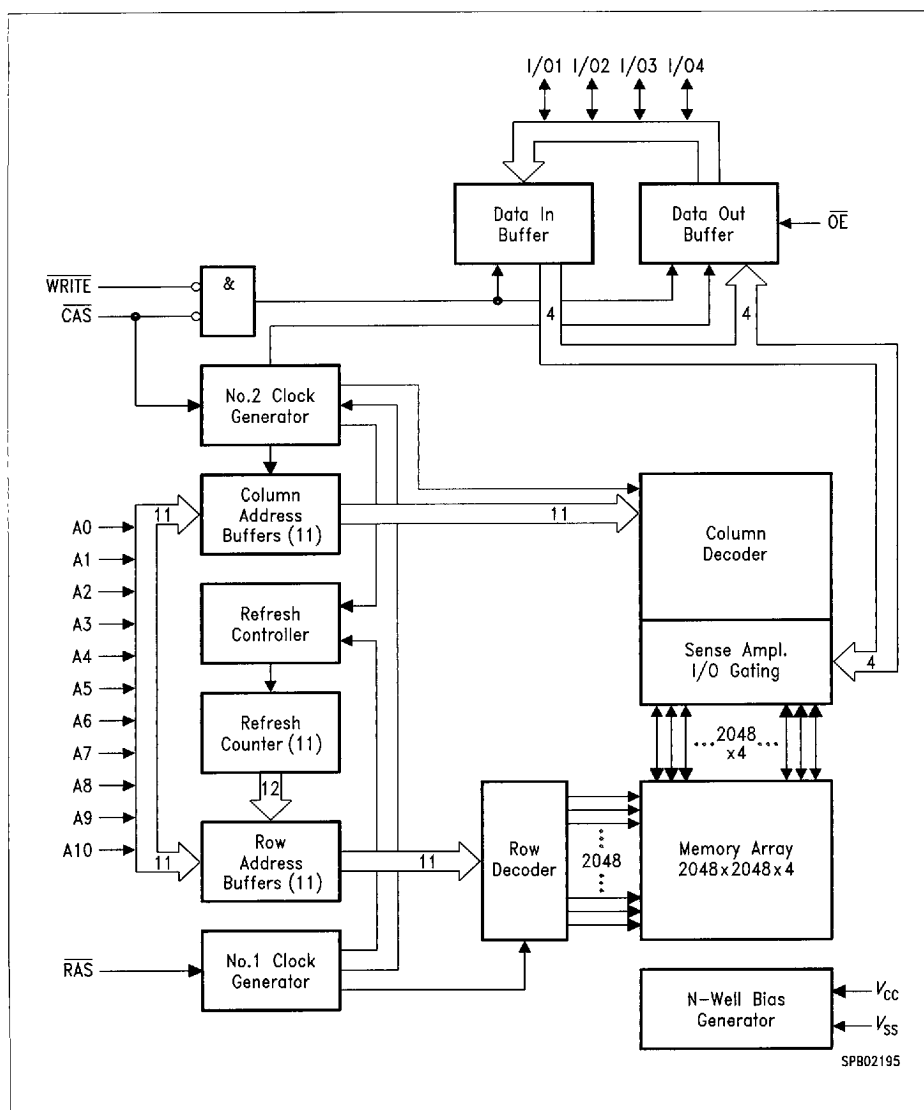
P-SOJ-28/24-1 (400 mil)



SPP02194

P-SOJ-26/24-1 (300 mil)

## Pin Configuration



Block Diagram

**Absolute Maximum Ratings**

|                                        |                                      |
|----------------------------------------|--------------------------------------|
| Operating temperature range .....      | 0 to 70 °C                           |
| Storage temperature range.....         | – 55 to 150 °C                       |
| Soldering temperature .....            | 260 °C                               |
| Soldering time.....                    | 10 s                                 |
| Input/output voltage .....             | – 0.5 to min ( $V_{CC}+0.5, 7.0$ ) V |
| Power supply voltage.....              | – 1.0 V to 7.0 V                     |
| Power dissipation.....                 | 1.0 W                                |
| Data out current (short circuit) ..... | 50 mA                                |

**Note:**

Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage of the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

**DC Characteristics**

$T_A = 0$  to 70 °C,  $V_{SS} = 0$  V,  $V_{CC} = 5$  V  $\pm 10\%$ ;  $t_T = 5$  ns

| Parameter                                                                                                                                                                                                                                                               | Symbol     | Limit Values     |                         | Unit                 | Test Condition                               |
|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------|------------------|-------------------------|----------------------|----------------------------------------------|
|                                                                                                                                                                                                                                                                         |            | min.             | max.                    |                      |                                              |
| Input high voltage                                                                                                                                                                                                                                                      | $V_{IH}$   | 2.4              | $V_{CC}+0.5$            | V                    | 1)                                           |
| Input low voltage                                                                                                                                                                                                                                                       | $V_{IL}$   | – 0.5            | 0.8                     | V                    | 1)                                           |
| Output high voltage ( $I_{OUT} = -5$ mA)                                                                                                                                                                                                                                | $V_{OH}$   | 2.4              | –                       | V                    | 1)                                           |
| Output low voltage ( $I_{OUT} = 4.2$ mA)                                                                                                                                                                                                                                | $V_{OL}$   | –                | 0.4                     | V                    | 1)                                           |
| Input leakage current<br>( $0 \text{ V} \leq V_{IH} \leq V_{CC} + 0.3 \text{ V}$ , all other pins = 0 V)                                                                                                                                                                | $I_{I(L)}$ | – 10             | 10                      | $\mu\text{A}$        | 1)                                           |
| Output leakage current<br>(DO is disabled, $0 \text{ V} \leq V_{OUT} \leq V_{CC} + 0.3 \text{ V}$ )                                                                                                                                                                     | $I_{O(L)}$ | – 10             | 10                      | $\mu\text{A}$        | 1)                                           |
| Average $V_{CC}$ supply current:<br>–50 ns version<br>–60 ns version<br>–70 ns version<br>–80 ns version<br>( $\overline{\text{RAS}}$ , $\overline{\text{CAS}}$ , address cycling: $t_{RC} = t_{RC \text{ min.}}$ )                                                     | $I_{CC1}$  | –<br>–<br>–<br>– | 120<br>110<br>100<br>90 | mA<br>mA<br>mA<br>mA | 2) 3) 4)<br>2) 3) 4)<br>2) 3) 4)<br>2) 3) 4) |
| Standby $V_{CC}$ supply current ( $\overline{\text{RAS}} = \overline{\text{CAS}} = V_{IH}$ )                                                                                                                                                                            | $I_{CC2}$  | –                | 2                       | mA                   | –                                            |
| Average $V_{CC}$ supply current, during $\overline{\text{RAS}}$ -only refresh cycles:<br>–50 ns version<br>–60 ns version<br>–70 ns version<br>–80 ns version<br>( $\overline{\text{RAS}}$ cycling: $\overline{\text{CAS}} = V_{IH}$ ; $t_{RC} = t_{RC \text{ min.}}$ ) | $I_{CC3}$  | –<br>–<br>–<br>– | 120<br>110<br>100<br>90 | mA<br>mA<br>mA<br>mA | 2) 4)<br>2) 4)<br>2) 4)<br>2) 4)             |

Notes see page 257.

### DC Characteristics (cont'd)

$T_A = 0$  to  $70^\circ\text{C}$ ,  $V_{SS} = 0\text{ V}$ ,  $V_{CC} = 5\text{ V} \pm 10\%$ ;  $t_T = 5\text{ ns}$

| Parameter                                                                                                                                                                                                                                                         | Symbol    | Limit Values     |                         | Unit                 | Test Condition                               |
|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------|------------------|-------------------------|----------------------|----------------------------------------------|
|                                                                                                                                                                                                                                                                   |           | min.             | max.                    |                      |                                              |
| Average $V_{CC}$ supply current, during fast page mode:<br>-50 ns version<br>-60 ns version<br>-70 ns version<br>-80 ns version<br>( $\overline{\text{RAS}} = V_{IL}$ , $\overline{\text{CAS}}$ , address cycling:<br>$t_{PC} = t_{PC\text{ min.}}$ )             | $I_{CC4}$ | —<br>—<br>—<br>— | 90<br>80<br>70<br>65    | mA<br>mA<br>mA<br>mA | 2) 3) 4)<br>2) 3) 4)<br>2) 3) 4)<br>2) 3) 4) |
| Standby $V_{CC}$ supply current<br>( $\overline{\text{RAS}} = \overline{\text{CAS}} = V_{CC} - 0.2\text{ V}$ )                                                                                                                                                    | $I_{CC5}$ | —                | 1                       | mA                   | 1)                                           |
| Average $V_{CC}$ supply current, during $\overline{\text{CAS}}$ -before-RAS refresh mode:<br>-50 ns version<br>-60 ns version<br>-70 ns version<br>-80 ns version<br>( $\overline{\text{RAS}}$ , $\overline{\text{CAS}}$ cycling: $t_{RC} = t_{RC\text{ min.}}$ ) | $I_{CC6}$ | —<br>—<br>—<br>— | 120<br>110<br>100<br>90 | mA<br>mA<br>mA<br>mA | 2) 4)<br>2) 4)<br>2) 4)<br>2) 4)             |

Notes see page 257.

**AC Characteristics** <sup>5)</sup> $T_A = 0 \text{ to } 70^\circ\text{C}$ ,  $V_{CC} = 5 \text{ V} \pm 10\%$ ,  $t_T = 5 \text{ ns}$ 

| Parameter                                         | Symbol     | Limit Values |      |      |      |      |      |      |      | Unit |
|---------------------------------------------------|------------|--------------|------|------|------|------|------|------|------|------|
|                                                   |            | -50          |      | -60  |      | -70  |      | -80  |      |      |
|                                                   |            | min.         | max. | min. | max. | min. | max. | min. | max. |      |
| Random read or write cycle time                   | $t_{RC}$   | 95           | —    | 110  | —    | 130  | —    | 150  | —    | ns   |
| Read-write cycle time                             | $t_{RWC}$  | 135          | —    | 150  | —    | 180  | —    | 200  | —    | ns   |
| Fast page mode cycle time                         | $t_{PC}$   | 35           | —    | 40   | —    | 45   | —    | 50   | —    | ns   |
| Fast page mode read-write cycle time              | $t_{PRWC}$ | 75           | —    | 80   | —    | 95   | —    | 100  | —    | ns   |
| Access time from RAS <sup>7) 12)</sup>            | $t_{RAC}$  | —            | 50   | —    | 60   | —    | 70   | —    | 80   | ns   |
| Access time from CAS <sup>7) 12)</sup>            | $t_{CAC}$  | —            | 15   | —    | 15   | —    | 20   | —    | 20   | ns   |
| Access time from column address <sup>7) 13)</sup> | $t_{AA}$   | —            | 25   | —    | 30   | —    | 35   | —    | 40   | ns   |
| Access time from CAS precharge <sup>7)</sup>      | $t_{CPA}$  | —            | 30   | —    | 35   | —    | 40   | —    | 45   | ns   |
| CAS to output in low-Z <sup>7)</sup>              | $t_{CLZ}$  | 0            | —    | 0    | —    | 0    | —    | 0    | —    | ns   |
| Output buffer turn-off delay <sup>8)</sup>        | $t_{OFF}$  | 0            | 15   | 0    | 15   | 0    | 20   | 0    | 20   | ns   |
| Transition time (rise and fall) <sup>6)</sup>     | $t_T$      | 3            | 50   | 3    | 50   | 3    | 50   | 3    | 50   | ns   |
| RAS precharge time                                | $t_{RP}$   | 35           | —    | 40   | —    | 50   | —    | 60   | —    | ns   |
| RAS pulse width                                   | $t_{RAS}$  | 50           | 10k  | 60   | 10k  | 70   | 10k  | 80   | 10k  | ns   |
| RAS pulse width (fast page mode)                  | $t_{RASp}$ | 50           | 200k | 60   | 200k | 70   | 200k | 80   | 200k | ns   |
| CAS precharge to RAS Delay                        | $t_{RHCP}$ | 30           | —    | 35   | —    | 40   | —    | 45   | —    | ns   |
| CAS precharge to WE (FPMR RMW)                    | $t_{CPWD}$ | 50           | —    | 55   | —    | 65   | —    | 70   | —    | ns   |
| RAS hold time                                     | $t_{RSH}$  | 15           | —    | 15   | —    | 20   | —    | 20   | —    | ns   |
| CAS hold time                                     | $t_{CSH}$  | 50           | —    | 60   | —    | 70   | —    | 80   | —    | ns   |

Notes see page 257.

**AC Characteristics** (cont'd) <sup>5)</sup> $T_A = 0$  to  $70\text{ }^{\circ}\text{C}$ ,  $V_{CC} = 5\text{ V} \pm 10\%$ ,  $t_T = 5\text{ ns}$ 

| Parameter                                              | Symbol    | Limit Values |      |      |      |      |      |      |      | Unit |
|--------------------------------------------------------|-----------|--------------|------|------|------|------|------|------|------|------|
|                                                        |           | -50          |      | -60  |      | -70  |      | -80  |      |      |
|                                                        |           | min.         | max. | min. | max. | min. | max. | min. | max. |      |
| CAS pulse width                                        | $t_{CAS}$ | 15           | 10k  | 15   | 10k  | 20   | 10k  | 20   | 10k  | ns   |
| RAS to CAS delay time <sup>12)</sup>                   | $t_{RCD}$ | 20           | 35   | 20   | 45   | 20   | 50   | 20   | 60   |      |
| RAS to column address delay time <sup>13)</sup>        | $t_{RAD}$ | 15           | 25   | 15   | 30   | 15   | 35   | 15   | 40   | ns   |
| CAS to RAS precharge time                              | $t_{CRP}$ | 5            | —    | 5    | —    | 5    | —    | 5    | —    | ns   |
| CAS precharge time                                     | $t_{CPN}$ | 10           | —    | 10   | —    | 10   | —    | 10   | —    | ns   |
| CAS precharge time (fast page mode)                    | $t_{CP}$  | 10           | —    | 10   | —    | 10   | —    | 10   | —    | ns   |
| Row address setup time                                 | $t_{ASR}$ | 0            | —    | 0    | —    | 0    | —    | 0    | —    | ns   |
| Row address hold time                                  | $t_{RAH}$ | 10           | —    | 10   | —    | 10   | —    | 10   | —    | ns   |
| Column address setup time                              | $t_{ASC}$ | 0            | —    | 0    | —    | 0    | —    | 0    | —    | ns   |
| Column address hold time                               | $t_{CAH}$ | 10           | —    | 15   | —    | 15   | —    | 15   | —    | ns   |
| Column address to RAS lead time                        | $t_{RAL}$ | 25           | —    | 30   | —    | 35   | —    | 40   | —    | ns   |
| Read command setup time                                | $t_{RCS}$ | 0            | —    | 0    | —    | 0    | —    | 0    | —    | ns   |
| Read command hold time <sup>9)</sup>                   | $t_{RCH}$ | 0            | —    | 0    | —    | 0    | —    | 0    | —    | ns   |
| Read command hold time referenced to RAS <sup>9)</sup> | $t_{RRH}$ | 0            | —    | 0    | —    | 0    | —    | 0    | —    | ns   |
| Write command hold time                                | $t_{WCH}$ | 10           | —    | 15   | —    | 15   | —    | 15   | —    | ns   |
| Write command pulse width                              | $t_{WP}$  | 10           | —    | 15   | —    | 15   | —    | 15   | —    | ns   |

Notes see page 257.



AC Characteristics (cont'd) <sup>5)</sup> $T_A = 0 \text{ to } 70^\circ\text{C}$ ,  $V_{CC} = 5 \text{ V} \pm 10\%$ ,  $t_T = 5 \text{ ns}$ 

| Parameter                                              | Symbol    | Limit Values |      |      |      |      |      |      |      | Unit |
|--------------------------------------------------------|-----------|--------------|------|------|------|------|------|------|------|------|
|                                                        |           | -50          |      | -60  |      | -70  |      | -80  |      |      |
|                                                        |           | min.         | max. | min. | max. | min. | max. | min. | max. |      |
| Write command to RAS lead time                         | $t_{RWL}$ | 15           | —    | 15   | —    | 20   | —    | 20   | —    | ns   |
| Write command to CAS lead time                         | $t_{CWL}$ | 15           | —    | 15   | —    | 20   | —    | 20   | —    | ns   |
| Data setup time <sup>10)</sup>                         | $t_{DS}$  | 0            | —    | 0    | —    | 0    | —    | 0    | —    | ns   |
| Data hold time <sup>10)</sup>                          | $t_{DH}$  | 10           | —    | 15   | —    | 15   | —    | 15   | —    | ns   |
| Refresh period                                         | $t_{REF}$ | —            | 32   | —    | 32   | —    | 32   | —    | 32   | ms   |
| Write command setup time <sup>11)</sup>                | $t_{WCS}$ | 0            | —    | 0    | —    | 0    | —    | 0    | —    | ns   |
| CAS to WRITE delay time <sup>11)</sup>                 | $t_{CWD}$ | 35           | —    | 35   | —    | 45   | —    | 45   | —    | ns   |
| RAS to WRITE delay time <sup>11)</sup>                 | $t_{RWD}$ | 70           | —    | 80   | —    | 95   | —    | 105  | —    | ns   |
| Column address to WRITE delay time <sup>11)</sup>      | $t_{AWD}$ | 45           | —    | 50   | —    | 60   | —    | 65   | —    | ns   |
| CAS setup time (CAS-before-RAS cycle)                  | $t_{CSR}$ | 10           | —    | 10   | —    | 10   | —    | 10   | —    | ns   |
| CAS hold time (CAS-before-RAS cycle)                   | $t_{CHR}$ | 30           | —    | 30   | —    | 30   | —    | 30   | —    | ns   |
| RAS to CAS precharge time                              | $t_{RPC}$ | 0            | —    | 0    | —    | 0    | —    | 0    | —    | ns   |
| CAS precharge time (CAS-before-RAS counter test cycle) | $t_{CPT}$ | 35           | —    | 40   | —    | 40   | —    | 40   | —    | ns   |
| Write command setup time (in test mode entry cycle)    | $t_{WTS}$ | 10           | —    | 10   | —    | 10   | —    | 10   | —    | ns   |
| Write command hold time (in test mode entry cycle)     | $t_{WTH}$ | 10           | —    | 10   | —    | 10   | —    | 10   | —    | ns   |

Notes see page 257.

### AC Characteristics (cont'd) <sup>5)</sup>

$T_A = 0$  to  $70$  °C,  $V_{CC} = 5$  V  $\pm$  10 %,  $t_T = 5$  ns

| Parameter                                                                                          | Symbol           | Limit Values |      |      |      |      |      |      |      | Unit |
|----------------------------------------------------------------------------------------------------|------------------|--------------|------|------|------|------|------|------|------|------|
|                                                                                                    |                  | -50          |      | -60  |      | -70  |      | -80  |      |      |
|                                                                                                    |                  | min.         | max. | min. | max. | min. | max. | min. | max. |      |
| Write to $\overline{\text{RAS}}$ precharge time ( $\overline{\text{CAS}}$ -before-RAS cycle)       | $t_{\text{WRP}}$ | 10           | —    | 10   | —    | 10   | —    | 10   | —    | ns   |
| Write hold time referenced to $\overline{\text{RAS}}$ ( $\overline{\text{CAS}}$ -before-RAS cycle) | $t_{\text{WRH}}$ | 10           | —    | 10   | —    | 10   | —    | 10   | —    | ns   |
| $\overline{\text{OE}}$ command hold time                                                           | $t_{\text{OEH}}$ | 15           | —    | 15   | —    | 20   | —    | 20   | —    | ns   |
| $\overline{\text{OE}}$ access time                                                                 | $t_{\text{OEA}}$ | —            | 15   | —    | 15   | —    | 20   | —    | 20   | ns   |
| Output buffer turn-off delay from $\overline{\text{OE}}$                                           | $t_{\text{OEZ}}$ | 0            | 15   | 0    | 15   | 0    | 20   | 0    | 20   | ns   |
| Data to $\overline{\text{CAS}}$ low delay <sup>15)</sup>                                           | $t_{\text{DZC}}$ | 0            | —    | 0    | —    | 0    | —    | 0    | —    | ns   |
| Data to $\overline{\text{OE}}$ low delay <sup>15)</sup>                                            | $t_{\text{DZO}}$ | 0            | —    | 0    | —    | 0    | —    | 0    | —    | ns   |
| $\overline{\text{CAS}}$ high to data delay <sup>16)</sup>                                          | $t_{\text{CDD}}$ | 15           | —    | 15   | —    | 20   | —    | 20   | —    | ns   |
| $\overline{\text{OE}}$ high to data delay <sup>16)</sup>                                           | $t_{\text{ODD}}$ | 15           | —    | 15   | —    | 20   | —    | 20   | —    | ns   |

Notes see page 257.

### Capacitance

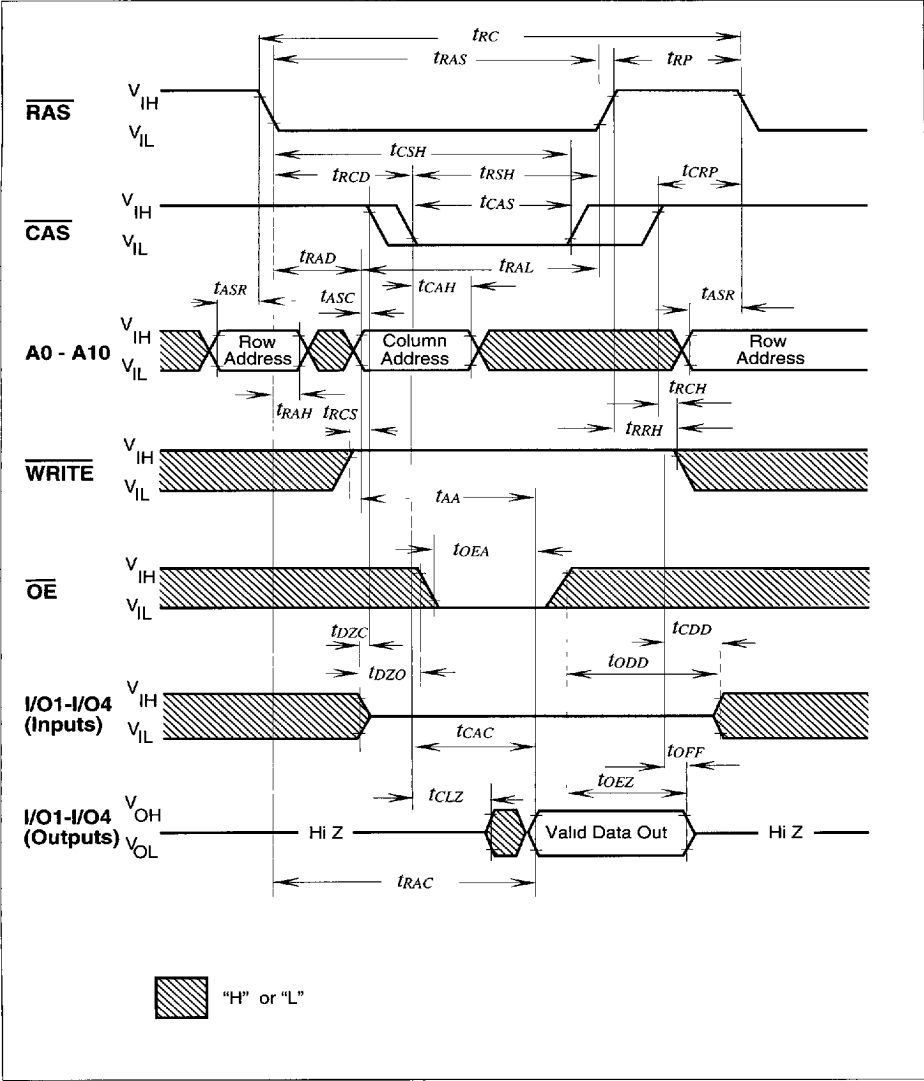
$T_A = 0$  to  $25$  °C,  $V_{CC} = 5$  V  $\pm$  10 %,  $f = 1$  MHz

| Parameter                                                                                                                    | Symbol   | Limit Values |      | Unit |
|------------------------------------------------------------------------------------------------------------------------------|----------|--------------|------|------|
|                                                                                                                              |          | min.         | max. |      |
| Input capacitance (A0 to A10)                                                                                                | $C_{I1}$ | —            | 5    | pF   |
| Input capacitance ( $\overline{\text{RAS}}$ , $\overline{\text{CAS}}$ , $\overline{\text{WRITE}}$ , $\overline{\text{OE}}$ ) | $C_{I2}$ | —            | 7    | pF   |
| I/O capacitance (I/O1-I/O4)                                                                                                  | $C_{I0}$ | —            | 7    | pF   |

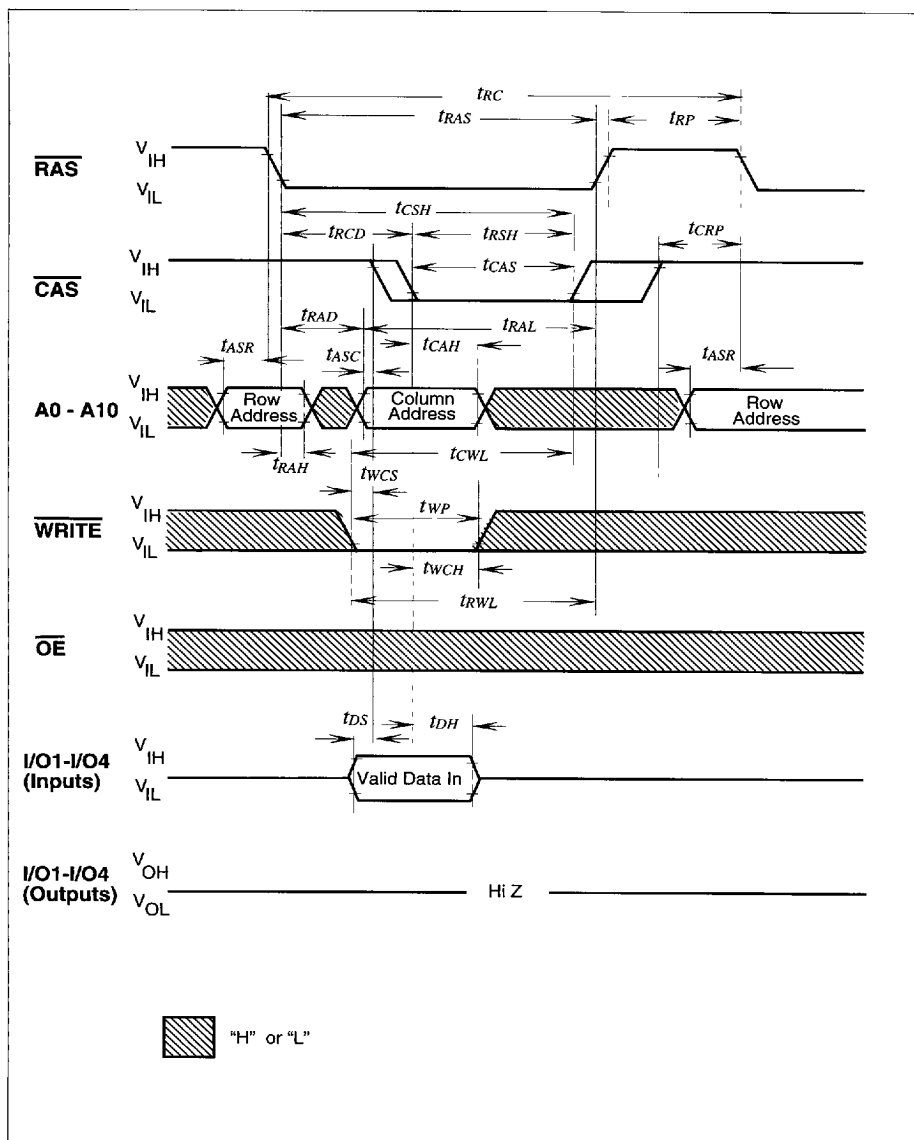
**Notes for pages 251 to 256:**

- 1) All voltages are referenced to  $V_{SS}$ .
- 2)  $I_{CC1}$ ,  $I_{CC3}$ ,  $I_{CC4}$  and  $I_{CC6}$  depend on cycle rate.
- 3)  $I_{CC1}$  and  $I_{CC4}$  depend on output loading. Specified values are measured with the output open.
- 4) Address can be changed once or less while  $\overline{RAS} = V_{IL}$ . In the case of  $I_{CC4}$  it can be changed once or less during a fast page mode cycle ( $t_{PC}$ ).
- 5) An initial pause of 200  $\mu s$  is required after power-up followed by 8  $\overline{RAS}$  cycles of which at least one cycle has to be a refresh cycle, before proper device operation is achieved. In case of using internal refresh counter, a minimum of 8 CAS-before-RAS initialization cycles instead of 8 RAS cycles are required.
- 6)  $V_{IH (min.)}$  and  $V_{IL (max.)}$  are reference levels for measuring timing of input signals. Transition times are also measured between  $V_{IH}$  and  $V_{IL}$ .
- 7) Measured with a load equivalent to 2 TTL loads and 100 pF.
- 8)  $t_{OFF (max.)}$  and  $t_{OEZ (max.)}$  define the time at which the outputs achieve the open-circuit condition and are not referenced to output voltage levels.
- 9) Either  $t_{RCH}$  or  $t_{RRH}$  must be satisfied for a read cycle.
- 10) These parameters are referenced to the  $\overline{CAS}$  leading edge in early write cycles and to the  $\overline{WRITE}$  leading edge in read-write cycles.
- 11)  $t_{WCS}$ ,  $t_{RWD}$ ,  $t_{CWD}$ ,  $t_{AWD}$  and  $t_{CPWD}$  are not restrictive operating parameters. They are included in the data sheet as electrical characteristics only. If  $t_{WCS} \geq t_{WCS (min.)}$ , the cycle is an early write cycle and the I/O pin will remain open-circuit (high impedance) through the entire cycle; if  $t_{RWD} \geq t_{RWD (min.)}$ ,  $t_{CWD} \geq t_{CWD (min.)}$ ,  $t_{AWD} \geq t_{AWD (min.)}$  and  $t_{CPWD} \geq t_{CPWD (min.)}$ , the cycle is a read-write cycle and I/O pins will contain data read from the selected cells. If neither of the above sets of conditions is satisfied, the condition of the I/O pins (at access time) is indeterminate.
- 12) Operation within the  $t_{RCD (max.)}$  limit ensures that  $t_{RAC (max.)}$  can be met.  $t_{RCD (max.)}$  is specified as a reference point only: If  $t_{RCD}$  is greater than the specified  $t_{RCD (max.)}$  limit, then access time is controlled by  $t_{CAC}$ .
- 13) Operation within the  $t_{RAD (max.)}$  limit ensures that  $t_{RAC (max.)}$  can be met.  $t_{RAD (max.)}$  is specified as a reference point only: If  $t_{RAD}$  is greater than the specified  $t_{RAD (max.)}$  limit, then access time is controlled by  $t_{AA}$ .
- 14) AC measurements assume  $t_T = 5$  ns.
- 15) Either  $t_{DZC}$  or  $t_{DZO}$  must be satisfied.
- 16) Either  $t_{CDD}$  or  $t_{ODD}$  must be satisfied.

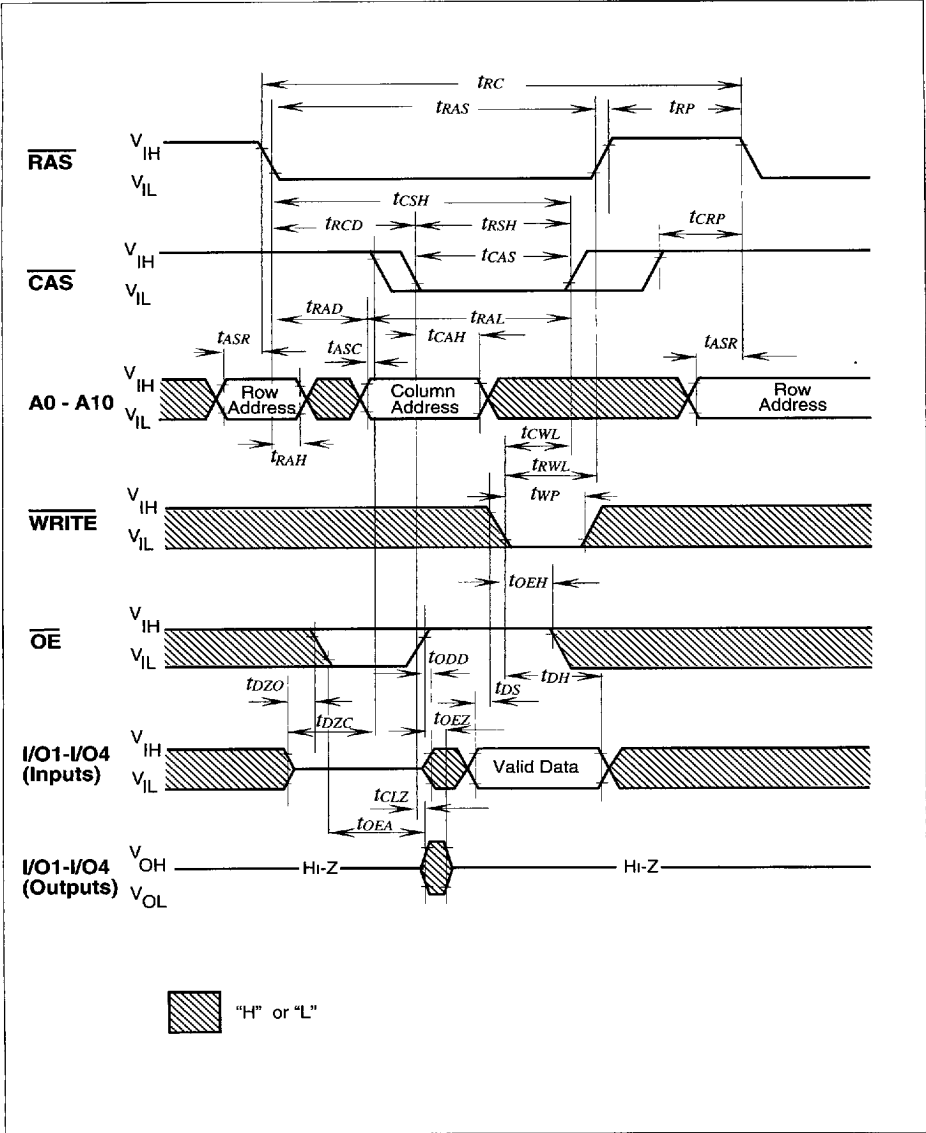
Waveforms



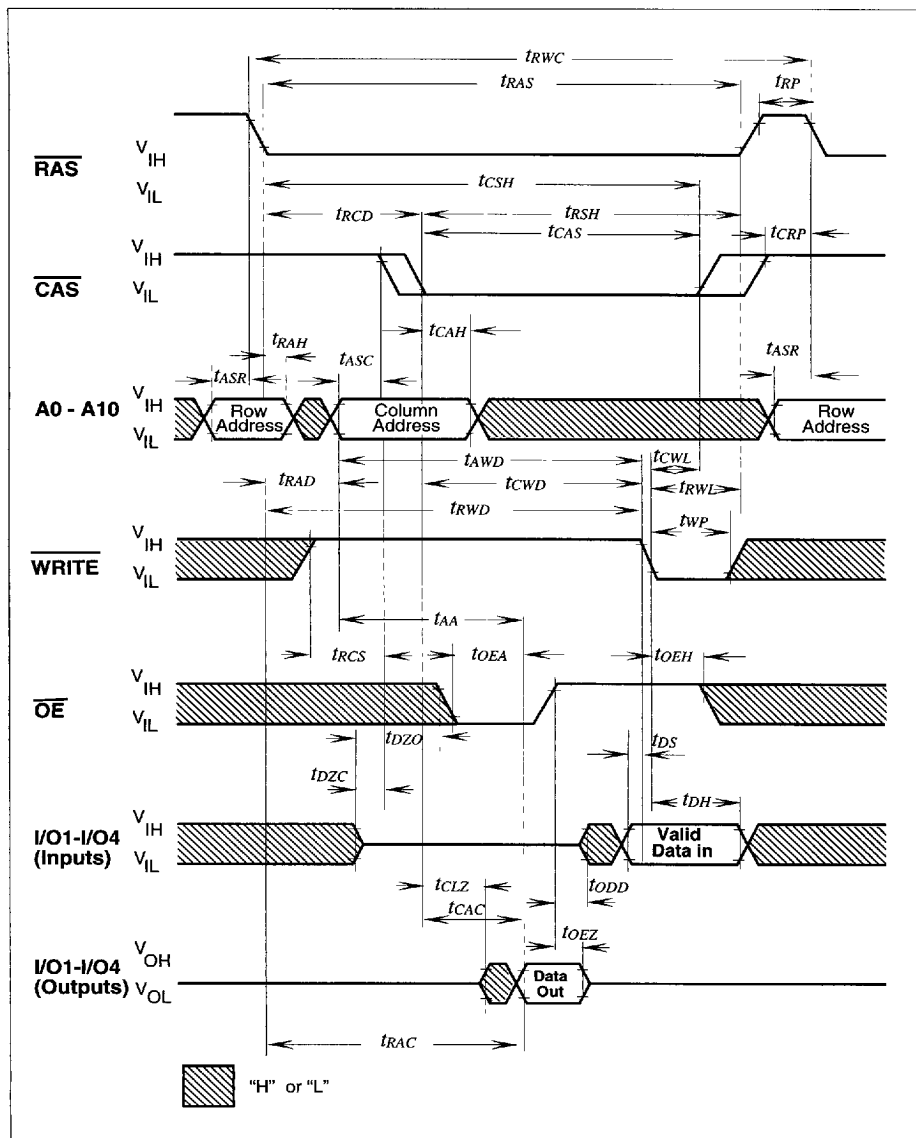
Read Cycle



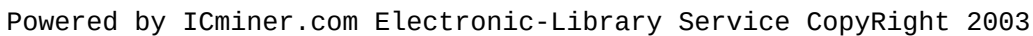
Write Cycle (Early Write)



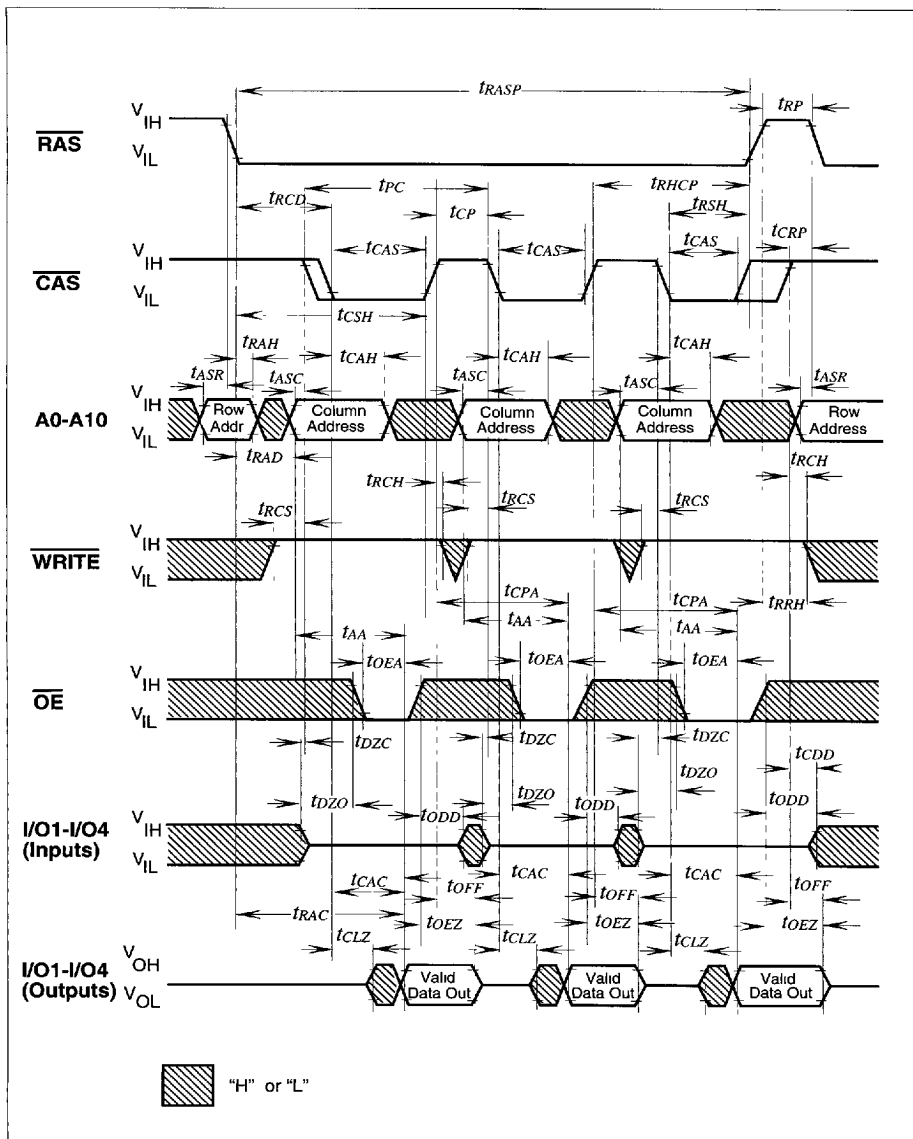
Write Cycle ( $\overline{OE}$  Controlled Write)



Read-Write (Read-Modify-Write) Cycle

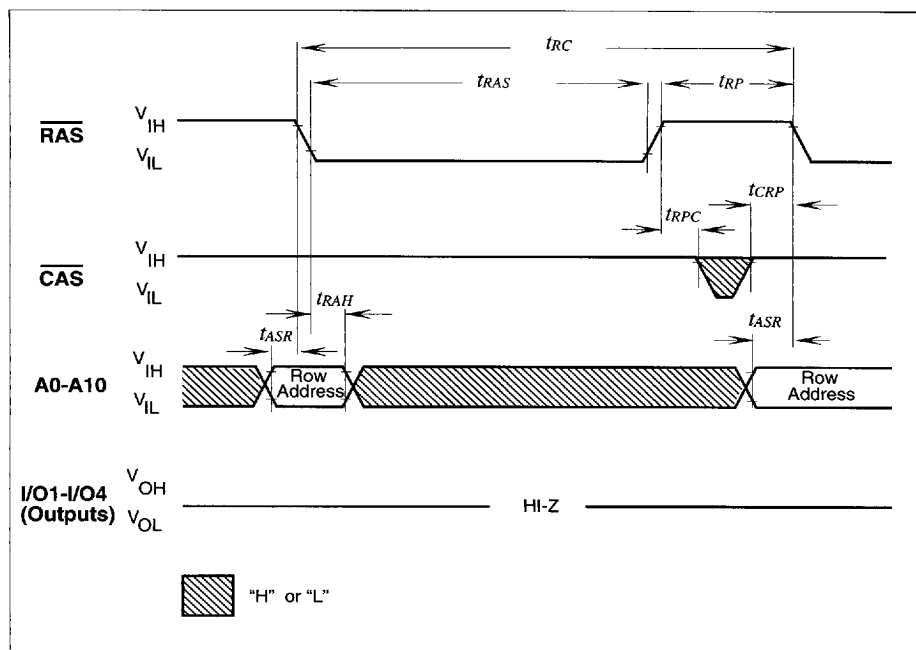


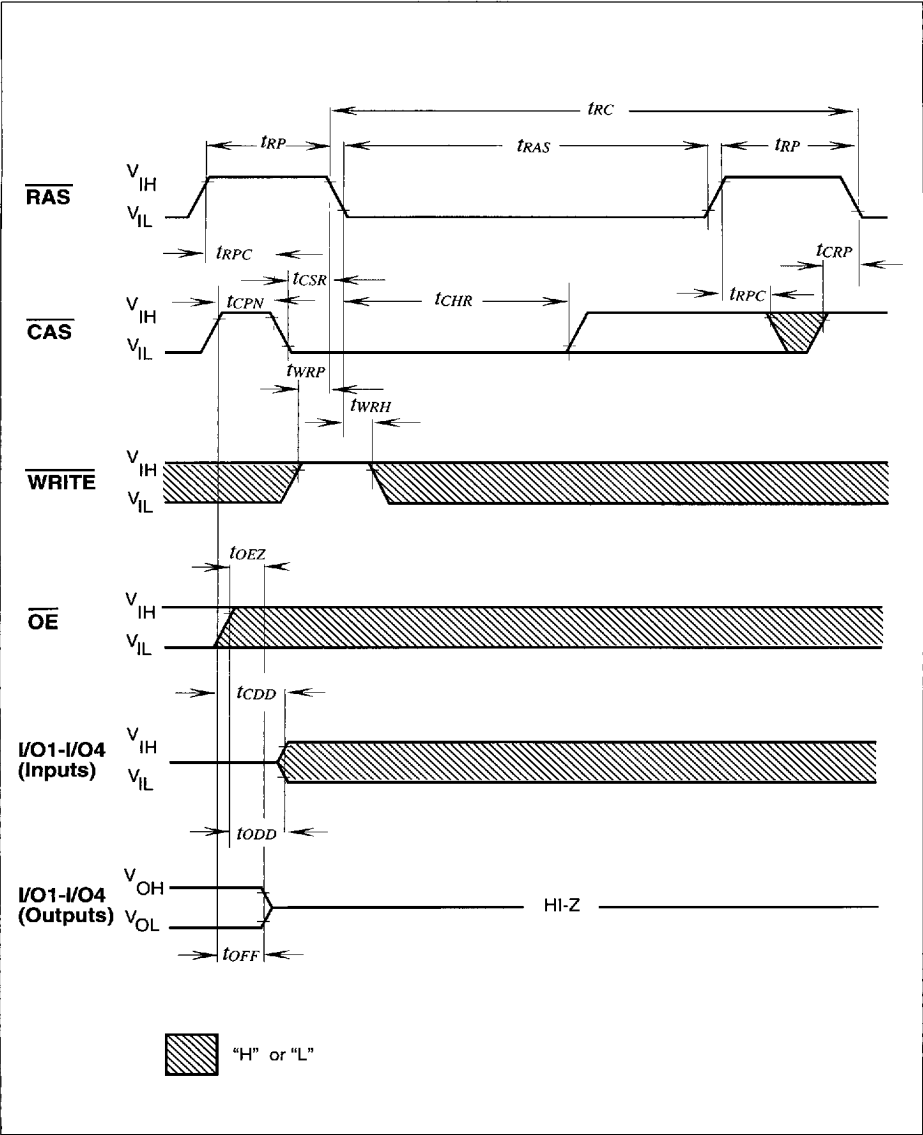




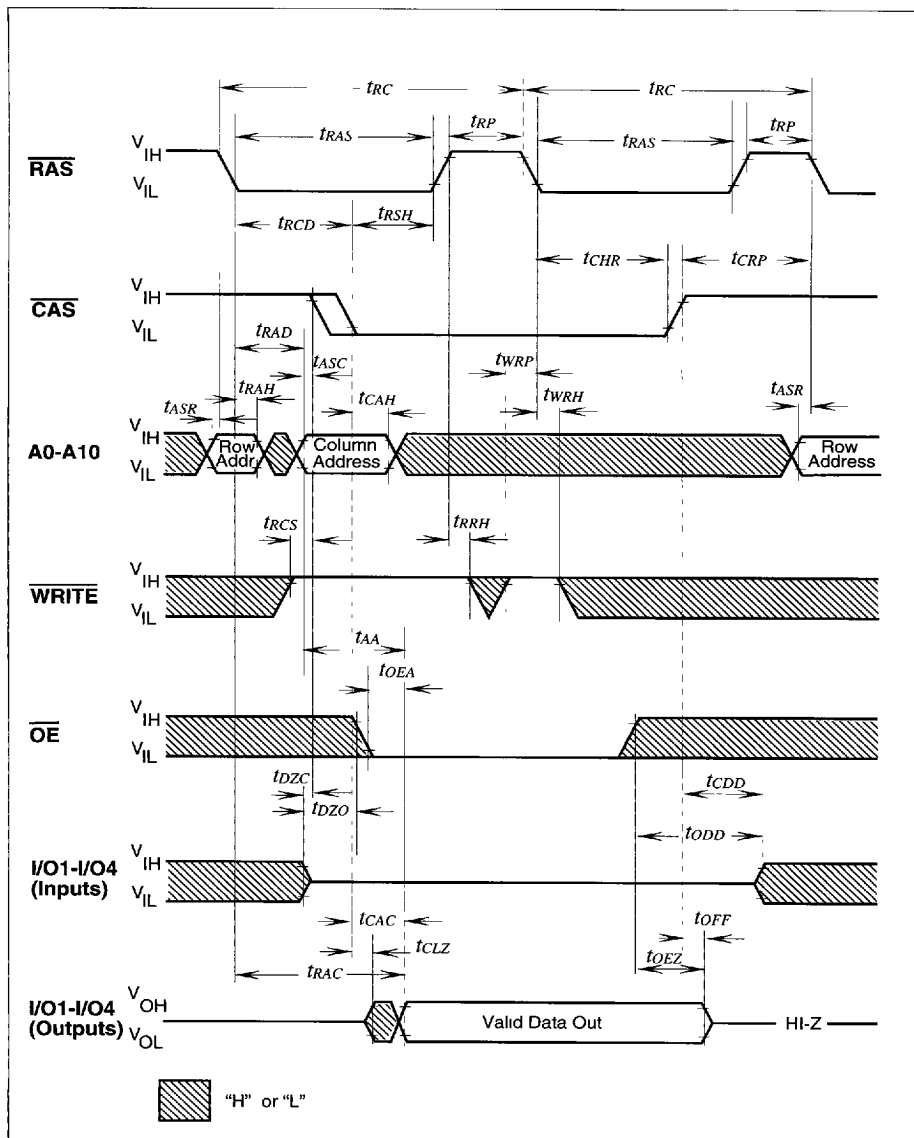
### Fast Page Mode Read Cycle



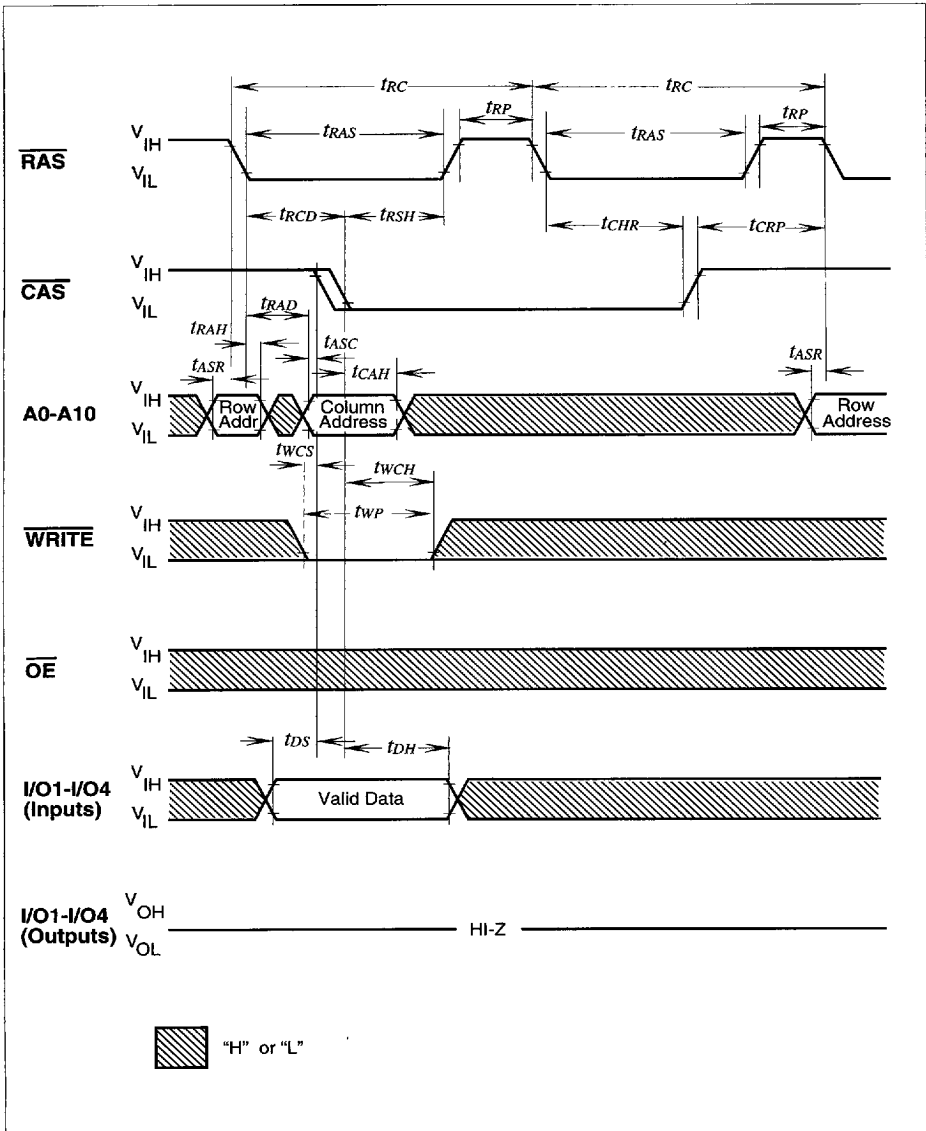
 $\overline{\text{RAS}}$ -Only Refresh Cycle



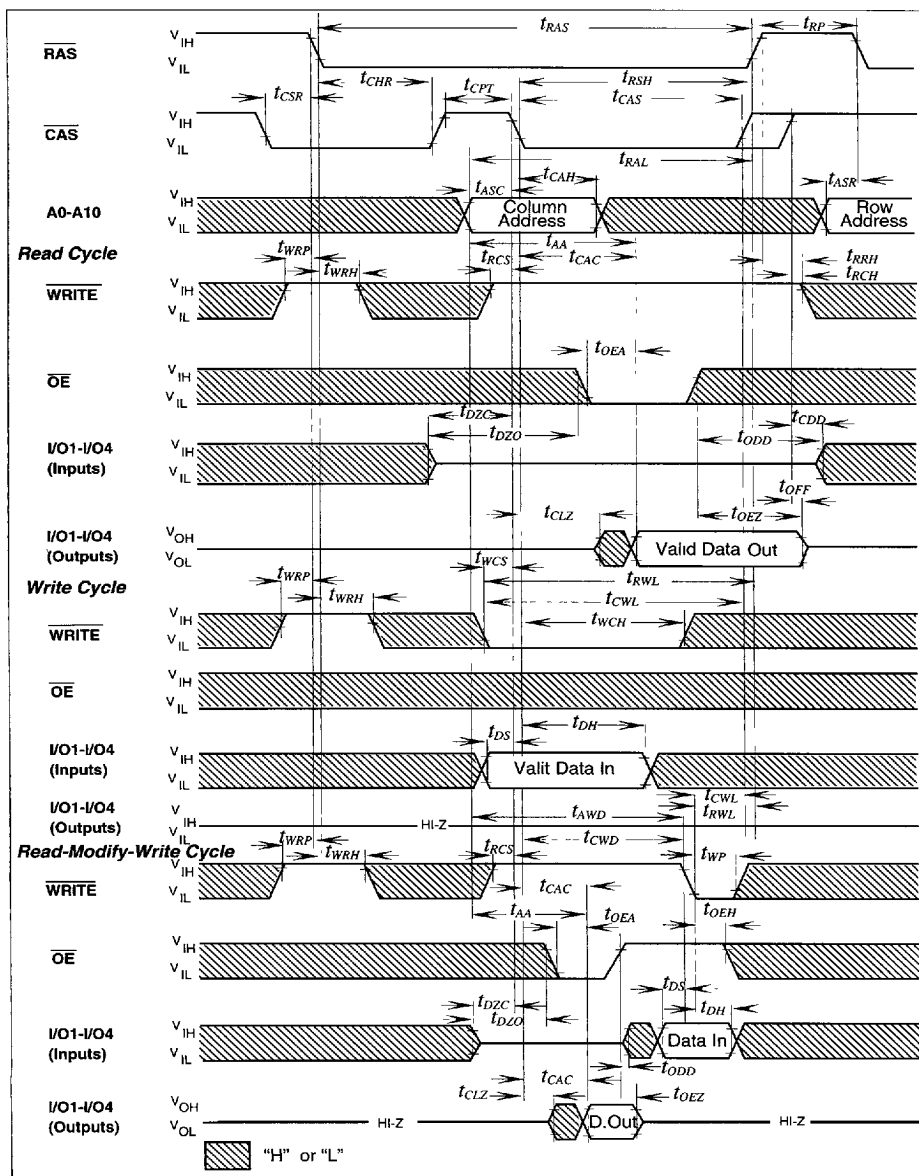
CAS-Before-RAS Refresh Cycle



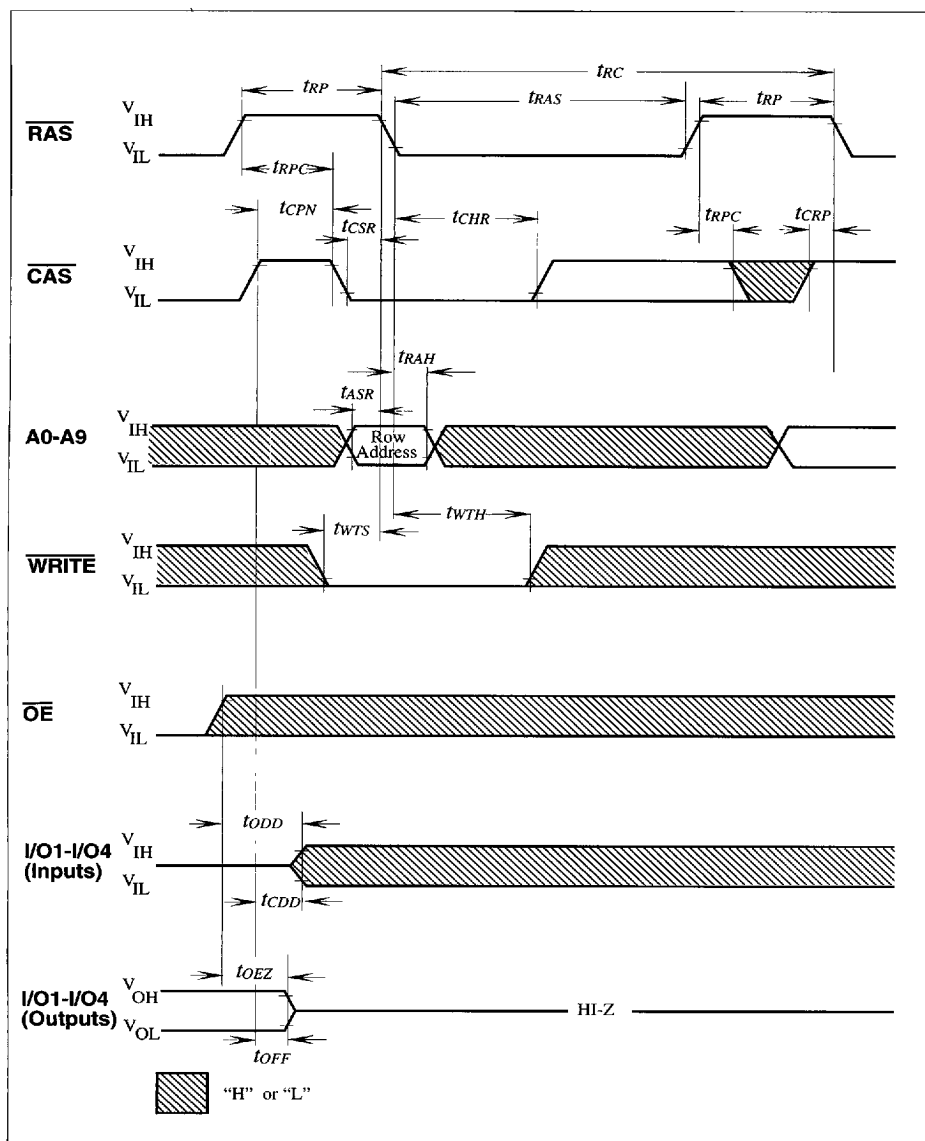
Hidden Refresh Cycle (Read)



Hidden Refresh Cycle (Early Write)



CAS-Before-RAS Refresh Counter Test Cycle



## Test Mode Entry

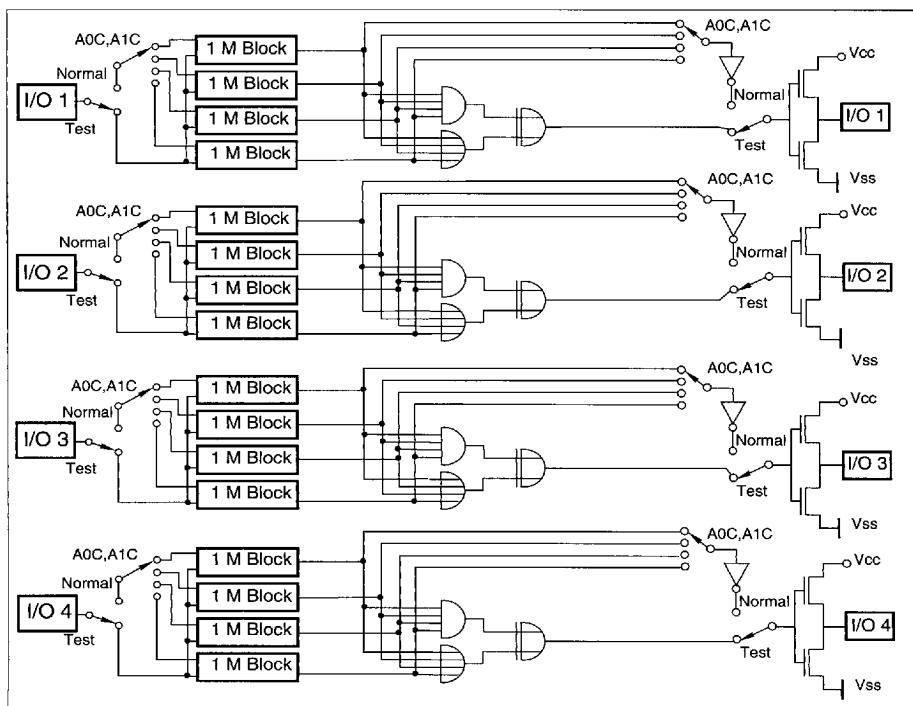


### Test Mode

As the HYB 5117400AJ/ASJ is organized internally as 1 M x 16-bits, a test mode cycle using 4:1 compression can be used to improve test time. Note that in the 4 M x 4 version the test time is reduced by 1/4 for a N test pattern.

In a test mode "write" the data from each I/O pin is written into four 1M blocks simultaneously (all "1"s or all "0"s). In test mode "read" each I/O output is used for indicating the test mode result. If the internal four bits are equal, the I/O would indicate a "1". If they were not equal, the I/O would indicate a "0". The WCBR cycle (WRITE, CAS before RAS) puts the device into test mode. To exit from test mode, a "CAS before RAS refresh", "RAS only refresh" or "Hidden refresh" can be used. Refresh during test mode operation can be performed by normal read cycles or by WCBR refresh cycles.

Row addresses A0 through A9 have to be kept high to perform a testmode entry cycle. All other addresses are don't care.



Block Diagram in Test Mode